Form-A

University of Hyderabad

Date: 04 September 2025

ADVERTISEMENT NO: UOH/SEST/VGK/DST/DST/TTI/ AMT/JRF-2025-02

1. Applications are invited from eligible candidates (Indian Nationals only) as per the attached format (*Form B*) for the following position(s) in the research project "Functionally Graded Hydrogen-free DLC as a replacement for Hard Chrome Plating for Piston Rings in Automotive Applications"

| 1 | Name of the post | Junior Research Fellow |
|---|--|--|
| 2 | Number of positions | One (01) |
| 3 | Fellowship / Honorarium / Stipend in Rs. | Rs 37,000+HRA per month as per the norms |
| 4 | Tenure of the Post | Initially for one year. Extendable till the end of the project depending on the progress of the RA reviewed yearly. |
| 5 | Essential Qualifications | Bachelor of Engineering/ Technology in Materials Engineering, Metallurgical Engineering, Mechanical Engineering, Nanoscience & technology (or) Master of Engineering/Technology in Materials Engineering, Metallurgical Engineering, Mechanical Engineering, Nanoscience & technology from reputed University/ Institution in India with ≥55% marks. |
| 6 | Desirable Qualifications and Experience | Prior work related to thin film deposition techniques PVD/CVD. Hands-on experience with XRD, Raman spectroscopy, SEM/EDX, nanoindentation, tribometer testing, XPS. |
| 7 | Age Limit | ≤ 28 years at the time of application with relaxation up to 5 years for SC/ST and 3 years for OBC candidates |
| 8 | Accommodation | Accommodation will not be provided by the University. |

- 2. Applicants should note that the appointments to be made are purely temporary and they have no right to claim for any regular appointment at the University.
- 3. No TA/DA will be paid at the time of joining.

- 4. Self-attested copies of all the certificates in support of the information furnished in the application should be enclosed.
- 5. Last date for receipt of filled-in applications either by post or by email is: 18th September 2025.
- 6. For technical information on the project, interested candidates may contact the Principal Investigator of the project: Dr. Venkata Girish Kotnur (vgk@uohyd.ac.in) over email.
- 7. The interview will be held via online/offline platform. The link will be shared with the eligible candidates only.
- 8. The decision of UoH in the selection of the candidates is final.
- 9. The selected candidate will be working with Dr.Venkata Girish Kotnur, School of Engineering Sciences & Technology, University of Hyderabad.
- 10. Address to which the application should be sent either by post or over email:

Dr. Venkata Girish Kotnur

Assistant Professor,

School of Engineering Sciences & Technology (New Building),

University of Hyderabad,

Prof. CR Rao Road, Gachibowli, Hyderabad – 500046.

Clearly mention the advertisement number on the envelope/in the subject without fail.

Email: vgk@uohyd.ac.in

(Dr. Venkata Girish Kotnur)

Name & Signature of the Project Investigator

To

- 1. Web Master, UoH with a request to place in the University site.
- 2. All the Notice Boards in the University of Hyderabad.
- 3. Reputed research institutions in the related area of the Project-for display on notice boards.

Application for the Position in the Project

| UNIVERSITY OF HYDERABAD P. O. Central University Campus, Gachibowli Hyderabad – 500 046, Telangana, INDIA | | | | | |
|---|----------------|--------------------|--|--|--|
| Application fee payment details: | Not Applicable | Recent Photograph | | | |
| Post Applied for: Notification No & Date: | | recent i notograph | | | |

Use separate sheets wherever necessary

| Perso | onal Details: | Proof enclosed Sl. No. |
|-------|---|------------------------|
| 1 | Full Name (as in SSC certificate) | |
| 2 | Gender (Male/Female) | |
| 3 | Date of Birth & Age (as on last date of the Notification) | |
| 4 | Father's Name | |
| 5 | Nationality | |
| 6 | Community (General / OBC / SC / ST / PWD) | |
| 7 | Married / Unmarried | |

| Candidate's Name & Address for correspondence: | | | | | |
|--|-----------------|-------------------|--|--|--|
| | Mailing address | Permanent address | | | |
| Name | | | | | |
| Address with PIN | | | | | |
| code | | | | | |
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| Elliali: | | | | | |
| Phone No. | | | | | |
| Mobile No. | | | | | |
| | | | | | |
| Fax No. | | | | | |
| Email: Phone No. Mobile No. Fax No. | | | | | |

| Present position held, i | if any: | | |
|--|--|---------------|-------------|
| Name of the University / Institution | Name of the Position and Salary Details | Nature of Job | Proof encl. |
| | | | |

| Educational | Qualifications | , | | | | | |
|--|--------------------------------------|---------------------------|---------------------|---------------|----------------------------------|---------------------|-----------------------|
| Name of the Examinatio n passed | Name of the Board / University | Month & Year passed | Division / Class | % of Marks | CGPA (if grading is applicab le) | Subjects studied | Proof Encl. No. |
| (a) | (b) | (c) | (d) | (e) | (f) | (g) | (h) |
| | | | | | | | |
| | | | | | | | |

| Experience (Including present position / employment) | | | | | | |
|--|-----------------------------------|---|-----|-----|----------------|---------------------|
| Designation & scale of pay | Name & Address of the Employer | Period of Experience No. of From To years/ date date Month s/days | | | Nature of work | Proof encl. Sl. No. |
| (a) | (b) | (c) | (d) | (e) | (f) | (g) |
| | | | | | | |
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| | | | | | | |

| Names & complete postal addresses of 2 referees : | | | |
|---|--|--------|--|
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| | | | |
| Email: | | Email: | |

| Phone (Landline) with STD Code: | Phone (Landline) with STD Code: |
|---------------------------------|---------------------------------|
| Mobile Ph: | Mobile Ph: |

| Declaration: I hereby declare that all the entries made by me in this application are true to the |
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| est of my knowledge and belief. If anything is found false at ant stage, my candidature may e cancelled without assigning any reason thereof. |
| Date: Signature of the applicant |